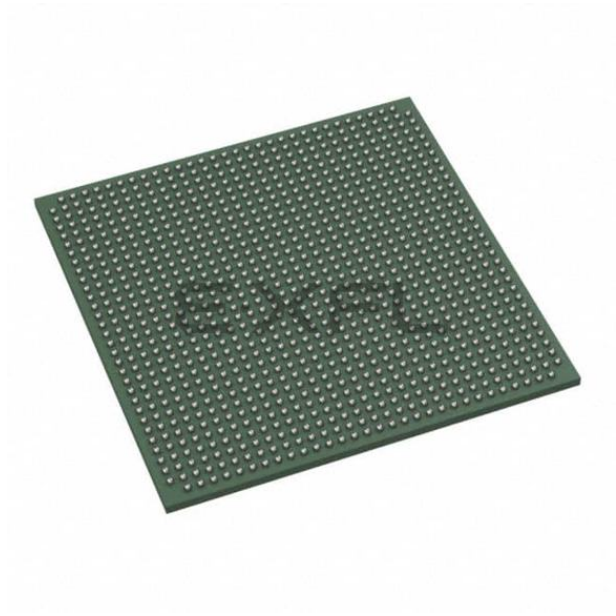
Lattice Semiconductor Corporation - LFSCM3GA40EP1-7FFN1020C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	562
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1020-BBGA, FCBGA
Supplier Device Package	1020-OFCBGA (33x33)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga40ep1-7ffn1020c

Modes of Operation

Each Slice is capable of four modes of operation: Logic, Ripple, RAM and ROM. Table 2-2 lists the modes and the capability of the Slice blocks.

Table 2-2. Slice Modes

	Logic	Ripple	RAM	ROM
PFU Slice	LUT 4x2 or LUT 5x1	2-bit Arithmetic Unit	SPR 16x2 DPR 16x2	ROM 16x2

Logic Mode

In this mode, the LUTs in each Slice are configured as combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any logic function with four inputs can be generated by programming this lookup table. Since there are two LUT4s per Slice, a LUT5 can be constructed within one Slice. Larger lookup tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other Slices in the PFU.

Ripple Mode

Ripple mode allows the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each Slice:

- Addition 2-bit
- Subtraction 2-bit
- Up counter 2-bit
- Down counter 2-bit
- Comparator functions of A and B inputs
  - A greater-than-or-equal-to B
  - A not-equal-to B
  - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

RAM Mode

In this mode, distributed RAM can be constructed using each LUT block as a 16x1-bit memory. Through the combination of LUTs and Slices, a variety of different memories can be constructed.

The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the Slice. Table 2-3 shows the number of Slices required to implement different distributed RAM primitives. Dual port memories involve the pairing of two Slices, one Slice functions as the read-write port. The other companion Slice supports the read-only port. For more information on RAM mode, please see details of additional technical documentation at the end of this data sheet.

Table 2-3. Number of Slices Required For Implementing Distributed RAM

	SPR16x2	DPR16x2
Number of Slices	1	2

Note: SPR = Single Port RAM, DPR = Dual Port RAM

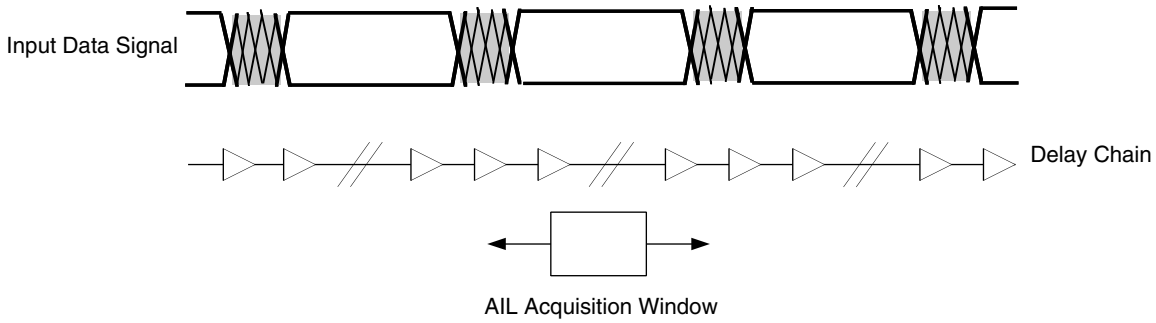
ROM Mode

The ROM mode uses the same principal as the RAM modes, but without the Write port. Pre-loading is accomplished through the programming interface during configuration.

Adaptive Input Logic (AIL) Overview

The Adaptive Input Logic (AIL) provides the ability of the input logic to dynamically find a solution by monitoring multiple samples of the input data. The input data signal from the input buffer is run through a delay chain. Data, transitions, jitter, noise are all contained inside of the delay chain. The AIL will then search the delay chain for a clean sampling point for data. Once found the AIL will monitor and walk with the data dynamically. This novel approach of using a delay chain to create multiple copies of the data provides a lower power solution than oversampling data with a higher speed clock. Figure 2-19 provides a high level view of the AIL methodology.

Figure 2-19. LatticeSC AIL Delay of Input Data Waveform



The AIL slides the acquisition window through the delay chain searching for stable data based solely on data transitions. A specific training pattern is not required to perform this bit alignment, simply data transitions. The size of the acquisition window is user-selectable allowing the AIL to operate over the full range of the PURESPEED I/O range. Based on dynamic user control the AIL can either continuously adjust the window location based on data edge detection or it can be locked to a specific delay.

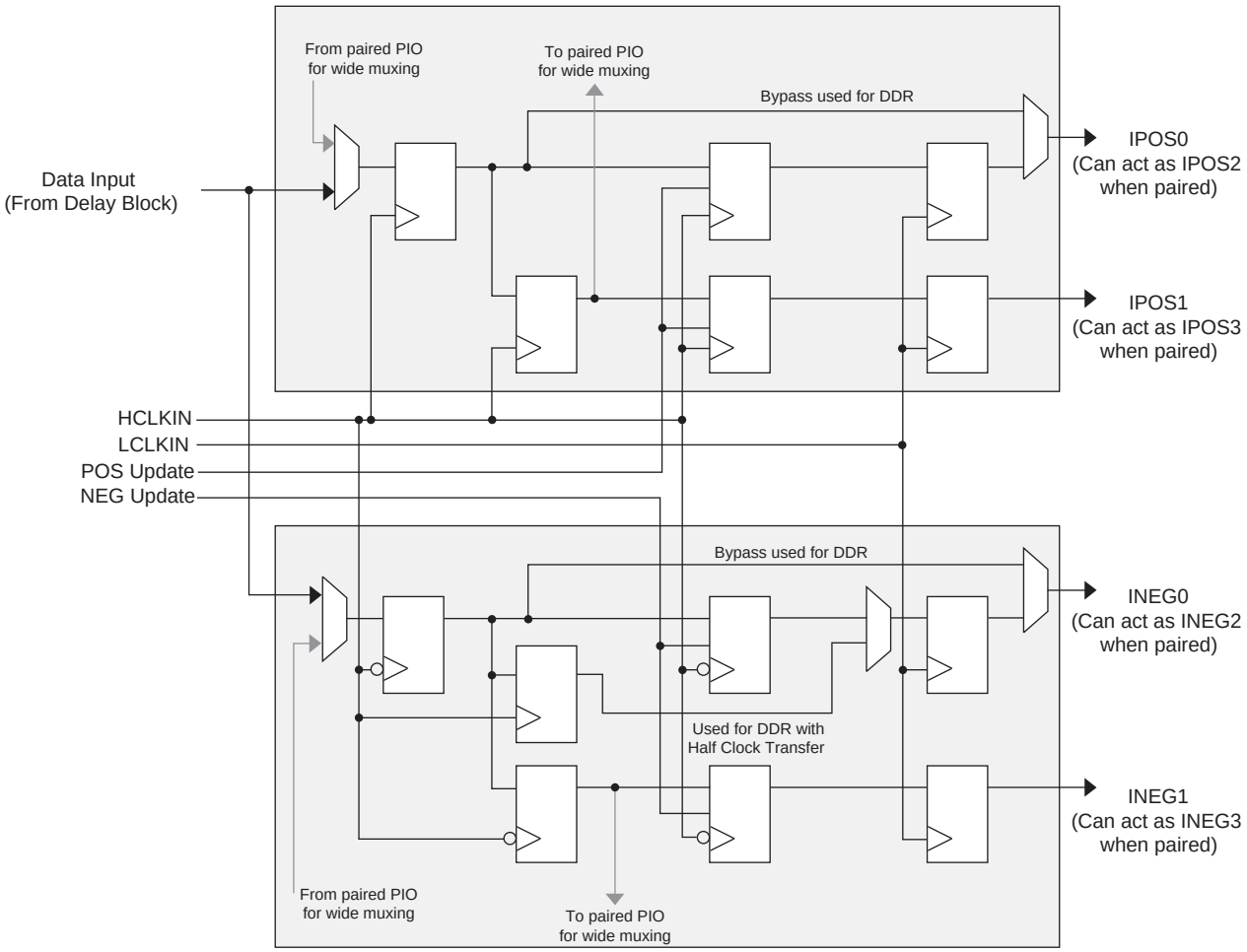
The AIL operates on single data and double data rate interfaces and is available on most FPGA input pins on the LatticeSC device and all buffer types. The AIL block is low power using only 0.003 mW/MHz typical (6 mW @ 2 Gbps) for PRBS 2^7 data. Multiple AIL inputs can be used to create a bus with a FPGA circuit to realign the bus to a common clock cycle. The FPGA circuit to realign the bus is required and is provided by Lattice as a reference design.

For more information on the LatticeSC AIL please refer to TN1158 LatticeSC PURESPEED I/O Adaptive Input Logic User's Guide.

Input DDR/Shift Block

The DDR/Shift block contains registers and associated logic that support DDR and shift register functions using the high-speed clock and the associated transfer to the low-speed clock domain. It functions as a gearbox allowing high-speed incoming data to be passed into the FPGA fabric. Each PIO supports DDR and x2 shift functions. If desired PIOs A and B or C and D can be combined to form x4 shift functions. The PIOs A and C on the left, right and bottom of the device also contain an optional Adaptive Input Logic (AIL) element. This logic automatically aligns incoming data with the clock allowing for easy design of high-speed interfaces. Figure 2-21 shows a simplified block diagram of the shift register block. The shift block in conjunction with the update and clock divider blocks automatically handles the hand off between the low-speed and high-speed clock domains.

Figure 2-21. Input DDR/Shift Register Block



Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of registers for DDR and shift register operation. The output signal (DO) can be derived directly from one of the inputs (bypass mode), the SDR register or the DDR/shift register block. Figure 2-22 shows the diagram of the Output Register Block.

Output SDR Register/Latch Block

The SDR register operates on the positive edge of the high-speed clock. It has clock enable that is driven by the clock enable output signal generated by the control MUX. In addition it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR (LSR has precedence over CE) and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR inputs is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Output DDR/Shift Block

The DDR/Shift block contains registers and associated logic that support DDR and shift register functions using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low-speed parallel data from the FPGA fabric be output as a higher speed serial stream. Each PIO supports DDR and x2 shift functions. If desired PIOs A and B or C and D can be combined to form x4 shift functions. Figure 2-22 shows a simplified block diagram of the shift register block.

Figure 2-26. LatticeSC Banks

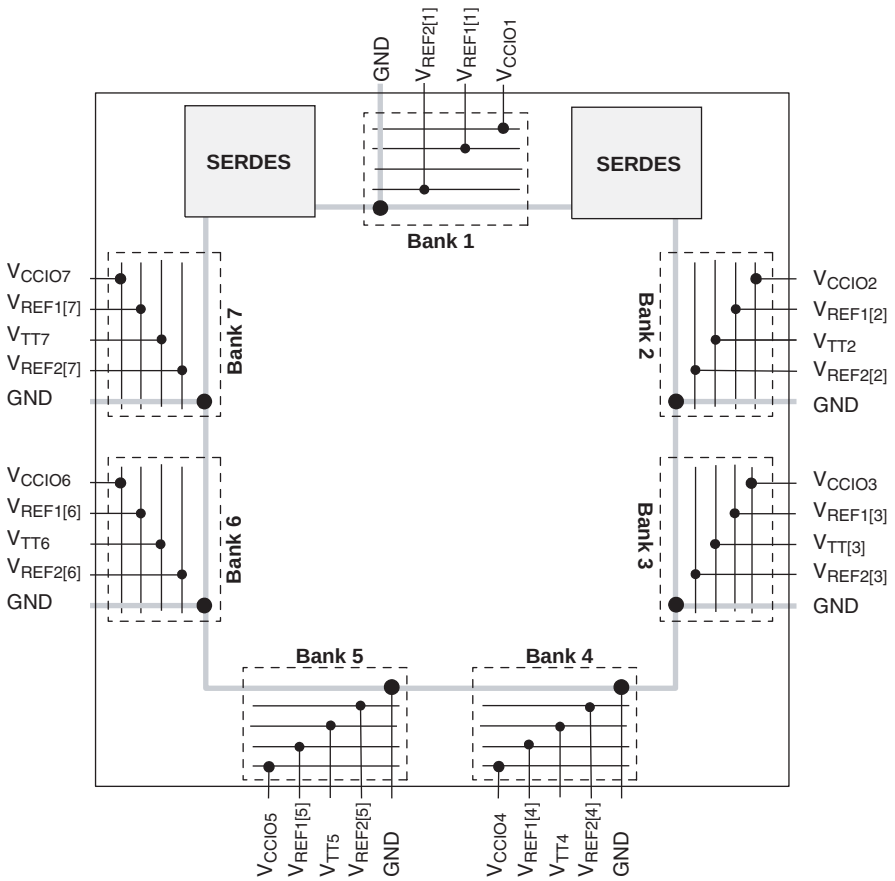


Table 2-7. Maximum Number of I/Os Per Bank in LatticeSC Family

Device	LFSC/M15	LFSC/M25	LFSC/M40	LFSC/M80	LFSC/M115
Bank1	104	80	136	80	136
Bank2	28	36	60	96	136
Bank3	60	84	96	132	156
Bank4	72	100	124	184	208
Bank5	72	100	124	184	208
Bank6	60	84	96	132	156
Bank7	28	36	60	96	136

Note: Not all the I/Os of the Banks are available in all the packages

The LatticeSC devices contain three types of PURESPEED I/O buffers:

1. **Left and Right Sides (Banks 2, 3, 6 and 7)**
   These buffers can support LVCMOS standards up to 2.5V. A differential output driver (for LVDS and RSDS) is provided on all primary PIO pairs (A and B) and differential receivers are available on all pairs. Complimentary drivers are available. Adaptive input logic is available on PIOs A or C.

2. **Top Side (Bank 1)**
   These buffers can support LVCMOS standards up to 3.3V, including PCI33, PCI-X33 and SSTL-33. Differential receivers are provided on all PIO pairs but differential drivers for LVDS and RSDS are not available. Adaptive input logic is not available on this side. Complimentary output drivers are available.

Density Shifting

The LatticeSC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

PURESPEED I/O Single-Ended DC Electrical Characteristics

Over Recommended Operating Conditions

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL} (mA)	I_{OH} (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 33	-0.3	0.8	2	3.465	0.4	2.4	24, 16, 8	-24, -16, -8
					0.2	VCCIO - 0.2	0.1	-0.1
LVTTL	-0.3	0.8	2	3.465	0.4	2.4	24, 16, 8	-24, -16, -8
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 25	-0.3	0.7	1.7	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 18	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 15	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 12	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.3	VCCIO - 0.3	12, 8, 4, 2	-12, -8, -4, -2
					0.2	VCCIO - 0.2	0.1	-0.1
PCIX15	-0.3	0.3VCCIO	0.5VCCIO	1.5	0.1VCCIO	0.9VCCIO	1.5	-0.5
PCI33	-0.3	0.3VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
PCIX33	-0.3	0.35VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
AGP-1X, AGP-2X	-0.3	0.3VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
SSTL3_I	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.7	VCCIO - 1.1	8	-8
SSTS3_I OST[2]	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.9	VCCIO - 1.3	8	-8
SSTL3_II	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.5	VCCIO - 0.9	16	-16
SSTL3_II OST[2]	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.9	VCCIO - 0.13	16	-16
SSTL2_I	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.54	VCCIO - 0.62	7.6	-7.6
SSTL2_I OST[2]	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.73	VCCIO - 0.81	7.6	-7.6
SSTL2_II	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.35	VCCIO - 0.43	15.2	-15.2
SSTL2_II OST[2]	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.73	VCCIO - 0.81	15.2	-15.2
SSTL18_I	-0.3	VREF - 0.125	VREF + 0.125	2.65	0.28	VCCIO - 0.28	13.4	-13.4
SSTL18_II	-0.3	VREF - 0.125	VREF + 0.125	2.65	0.28	VCCIO - 0.28	13.4	-13.4
HSTL15_I	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	8	-8
HSTL15_II	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	16	-16
HSTL15_III[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL15_IV[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL18_I	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	9.6	-9.6
HSTL18_II	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	19.2	-19.2
HSTL18_III[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL18_IV[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
GTL12[1], GTLPLUS15[1]	-0.3	VREF - 0.2	VREF + 0.2	N/A	N/A	N/A	N/A	N/A

1. Input only.
2. Input with on-chip series termination.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
D[n:0]	I/O	In parallel configuration modes, D[7:0] receives configuration data, and each pin is pull-up enabled. For slave serial mode, D0 is the data input. D[7:3] is the output internal status for peripheral mode when RDN is low. D[7:0] is also the first byte of MPI data pins. In MPI configuration mode, MPI selectable data bus width from 8 and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
DP[m:0]	I/O	MPI selectable parity data bus width from 1, 2, and 3-bit DP[0] for D[7:0], DP[1] for D[15:8], and DP[2] for D[23:16].
BUSYN/RCLK/SCK	O	During configuration in peripheral mode, high on BUSYN indicates another byte can be written to the FPGA. If a read operation is done when the device is selected, the same status is also available on D[7] in asynchronous peripheral mode. During configuration in slave parallel mode, low on BUSYN inhibits the external host from sending new data. The output is used by slave parallel and master serial modes only for decompression. During configuration in master parallel and master byte modes, RCLK is a read clock output signal to an external memory. The RCLK frequency is the same as CCLK when used with uncompressed bitstreams. RCLK will be 1/8 the frequency of CCLK when the bitstream is compressed. During configuration in SPI modes, SCK is generated by the device and connected to the CLK input of the FLASH memory.
MPI Interface (Dedicated pin)		
MPI_IRQ_N	O	MPI Interrupt request active low signal is controlled by system bus interrupt controller and may be sourced from any bus error or MPI configuration error. It can be connected to one of MPC860 IRQ pins.
MPI Interface (User I/O if MPI is not used.)		
MPI_CS0N MPI_CS1	I	MPI chip select pins, active low on MPI_CS0N while active high on MPI_CS1. Both have to be active during the whole transfer data phase. During transfer address phase, both can be inactive so that the decoding for them from address can be slow. If they are active during address phase, one cycle can be saved for sync read.
MPI_CLK	I	This is the PowerPC bus clock. It can be a source of the clock for embedded system bus. If MPI_CLK is used as system bus clock, MPI will be set into sync mode by default. All of the operation on PowerPC side of MPI are synchronized to the rising edge of this clock.
MPI_TSIZ[1:0]	I	Driven by a bus master to indicate the data transfer size for the transaction. 01 for byte, 10 for half-word, and 00 for word.
MPI_WR_N	I	Driven high indicates that a read access is in progress. Driven low indicates that a write access is in process.
MPI_BURST	I	Driven active low indicates that a burst transfer is in progress. Driven high indicates that the current transfer is not a burst.
MPI_BDIP	I	Active low “Burst Data in Process” is driven by a PowerPC processor. Asserted indicates that the second beat in front of the current one is requested by the master. Negated before the burst transfer ends to abort the burst data phase.

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
F14	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
E15	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
E14	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
D9	VCCJ	-	
C16	TDO	-	TDO
B15	TMS	-	
B16	TCK	-	
E13	TDI	-	
C14	PROGRAMN	1	
C15	CCLK	1	
A15	PT43D	1	HDC/SI
A14	PT43C	1	LDCN/SCS
B14	PT41A	1	CS1
E12	PT39B	1	CS0N
D13	PT39A	1	RDN
D12	PT37D	1	WRN
E10	PT37C	1	D7
C11	PT37B	1	D6
D10	PT37A	1	D5
A13	PT36D	1	D4
B12	PT36C	1	D3
A12	PT35B	1	D2
C12	PT35A	1	D1
A11	PT33B	1	D0
B11	PT33A	1	QOUT/CEON
E9	PT32D	1	VREF2_1
E8	PT32B	1	DOUT
D8	PT28C	1	BUSYN/RCLK/SCK
A10	PT27B	1	PCLKC1_0
C10	PT27A	1	PCLKT1_0
E7	PT21C	1	VREF1_1
C9	A_VDDIB3_L	-	
A9	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N
A8	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B8	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C8	A_VDDOB3_L	-	
B7	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C7	A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
B6	A_HDINN2_L	-	PCS 360 CH 2 IN N
A6	A_HDINP2_L	-	PCS 360 CH 2 IN P
C6	A_VDDIB2_L	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W24	VCCAUX	-		VCCAUX	-	
AC17	VCCAUX	-		VCCAUX	-	
AC18	VCCAUX	-		VCCAUX	-	
AC19	VCCAUX	-		VCCAUX	-	
AD17	VCCAUX	-		VCCAUX	-	
AD18	VCCAUX	-		VCCAUX	-	
AD19	VCCAUX	-		VCCAUX	-	
AC12	VCCAUX	-		VCCAUX	-	
AC13	VCCAUX	-		VCCAUX	-	
AC14	VCCAUX	-		VCCAUX	-	
AD12	VCCAUX	-		VCCAUX	-	
AD13	VCCAUX	-		VCCAUX	-	
AD14	VCCAUX	-		VCCAUX	-	
U7	VCCAUX	-		VCCAUX	-	
U8	VCCAUX	-		VCCAUX	-	
V7	VCCAUX	-		VCCAUX	-	
V8	VCCAUX	-		VCCAUX	-	
W7	VCCAUX	-		VCCAUX	-	
W8	VCCAUX	-		VCCAUX	-	
M7	VCCAUX	-		VCCAUX	-	
M8	VCCAUX	-		VCCAUX	-	
N7	VCCAUX	-		VCCAUX	-	
N8	VCCAUX	-		VCCAUX	-	
H10	VCCIO1	-		VCCIO1	-	
H21	VCCIO1	-		VCCIO1	-	
H22	VCCIO1	-		VCCIO1	-	
H9	VCCIO1	-		VCCIO1	-	
J11	VCCIO1	-		VCCIO1	-	
J12	VCCIO1	-		VCCIO1	-	
J13	VCCIO1	-		VCCIO1	-	
J14	VCCIO1	-		VCCIO1	-	
J15	VCCIO1	-		VCCIO1	-	
J16	VCCIO1	-		VCCIO1	-	
J17	VCCIO1	-		VCCIO1	-	
J18	VCCIO1	-		VCCIO1	-	
J19	VCCIO1	-		VCCIO1	-	
J20	VCCIO1	-		VCCIO1	-	
J23	VCCIO2	-		VCCIO2	-	
J24	VCCIO2	-		VCCIO2	-	
K23	VCCIO2	-		VCCIO2	-	
K24	VCCIO2	-		VCCIO2	-	
L22	VCCIO2	-		VCCIO2	-	
L23	VCCIO2	-		VCCIO2	-	
M22	VCCIO2	-		VCCIO2	-	
N22	VCCIO2	-		VCCIO2	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
Y6	PR42D	3	DIFFR_3	PR51D	3	DIFFR_3
W6	PR42C	3		PR51C	3	
Y2	PR42B	3		PR51B	3	
W2	PR42A	3		PR51A	3	
W7	PR40D	3		PR49D	3	
V8	PR40C	3		PR49C	3	
W4	PR40B	3		PR49B	3	
W3	PR40A	3		PR49A	3	
V5	PR39D	3		PR48D	3	
U6	PR39C	3		PR48C	3	
V3	PR39B	3		PR48B	3	
V4	PR39A	3		PR48A	3	
V10	PR38D	3		PR47D	3	
V9	PR38C	3		PR47C	3	
V2	PR38B	3		PR47B	3	
V1	PR38A	3		PR47A	3	
U8	PR36D	3		PR45D	3	
U7	PR36C	3		PR45C	3	
U2	PR36B	3		PR45B	3	
U1	PR36A	3		PR45A	3	
U5	PR35D	3		PR44D	3	
T6	PR35C	3		PR44C	3	
T1	PR35B	3		PR44B	3	
T2	PR35A	3		PR44A	3	
U9	PR34D	3		PR43D	3	
U10	PR34C	3	VREF1_3	PR43C	3	VREF1_3
R1	PR34B	3		PR43B	3	
R2	PR34A	3		PR43A	3	
T7	PR31D	3	PCLKC3_2	PR40D	3	PCLKC3_2
T8	PR31C	3	PCLKT3_2	PR40C	3	PCLKT3_2
R4	PR31B	3		PR40B	3	
R3	PR31A	3		PR40A	3	
T5	PR30D	3	PCLKC3_3	PR39D	3	PCLKC3_3
R5	PR30C	3	PCLKT3_3	PR39C	3	PCLKT3_3
P2	PR30B	3		PR39B	3	
P1	PR30A	3		PR39A	3	
T9	PR29D	3	PCLKC3_1	PR38D	3	PCLKC3_1
T10	PR29C	3	PCLKT3_1	PR38C	3	PCLKT3_1
P4	PR29B	3	PCLKC3_0	PR38B	3	PCLKC3_0
P3	PR29A	3	PCLKT3_0	PR38A	3	PCLKT3_0
P5	PR27D	2	PCLKC2_2	PR36D	2	PCLKC2_2
P6	PR27C	2	PCLKT2_2	PR36C	2	PCLKT2_2
N1	PR27B	2	PCLKC2_0	PR36B	2	PCLKC2_0
N2	PR27A	2	PCLKT2_0	PR36A	2	PCLKT2_0
R9	PR26D	2	PCLKC2_3	PR35D	2	PCLKC2_3
R8	PR26C	2	PCLKT2_3	PR35C	2	PCLKT2_3
M1	PR26B	2	PCLKC2_1	PR35B	2	PCLKC2_1
L1	PR26A	2	PCLKT2_1	PR35A	2	PCLKT2_1
N9	PR25D	2	DIFFR_2	PR23D	2	DIFFR_2
M9	PR25C	2	VREF1_2	PR23C	2	VREF1_2

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B1	GND	-		GND	-	
B32	GND	-		GND	-	
C11	GND	-		GND	-	
C12	GND	-		GND	-	
C16	GND	-		GND	-	
C21	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C25	GND	-		GND	-	
C26	GND	-		GND	-	
C27	GND	-		GND	-	
C29	GND	-		GND	-	
C3	GND	-		GND	-	
C30	GND	-		GND	-	
C4	GND	-		GND	-	
C6	GND	-		GND	-	
C7	GND	-		GND	-	
C8	GND	-		GND	-	
C9	GND	-		GND	-	
D17	GND	-		GND	-	
F18	GND	-		GND	-	
F3	GND	-		GND	-	
F30	GND	-		GND	-	
F9	GND	-		GND	-	
G15	GND	-		GND	-	
G24	GND	-		GND	-	
G29	GND	-		GND	-	
G3	GND	-		GND	-	
J14	GND	-		GND	-	
J22	GND	-		GND	-	
J26	GND	-		GND	-	
J6	GND	-		GND	-	
K11	GND	-		GND	-	
K19	GND	-		GND	-	
K30	GND	-		GND	-	
K4	GND	-		GND	-	
L23	GND	-		GND	-	
L9	GND	-		GND	-	
M13	GND	-		GND	-	
M15	GND	-		GND	-	
M18	GND	-		GND	-	
M20	GND	-		GND	-	
M27	GND	-		GND	-	
M7	GND	-		GND	-	
N12	GND	-		GND	-	
N14	GND	-		GND	-	
N19	GND	-		GND	-	
N21	GND	-		GND	-	
N29	GND	-		GND	-	
N3	GND	-		GND	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D7	B_VDDIB0_R	-		B_VDDIB0_R	-	
E10	B_HDINP0_R	-	PCS 3E1 CH 0 IN P	B_HDINP0_R	-	PCS 3E1 CH 0 IN P
F10	B_HDINN0_R	-	PCS 3E1 CH 0 IN N	B_HDINN0_R	-	PCS 3E1 CH 0 IN N
K10	VCC12	-		VCC12	-	
A11	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P
D10	B_VDDOB0_R	-		B_VDDOB0_R	-	
B11	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N
D11	B_VDDOB1_R	-		B_VDDOB1_R	-	
B12	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N
L10	VCC12	-		VCC12	-	
A12	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P
F11	B_HDINN1_R	-	PCS 3E1 CH 1 IN N	B_HDINN1_R	-	PCS 3E1 CH 1 IN N
E11	B_HDINP1_R	-	PCS 3E1 CH 1 IN P	B_HDINP1_R	-	PCS 3E1 CH 1 IN P
G11	VCC12	-		VCC12	-	
D8	B_VDDIB1_R	-		B_VDDIB1_R	-	
G12	VCC12	-		VCC12	-	
D9	B_VDDIB2_R	-		B_VDDIB2_R	-	
E12	B_HDINP2_R	-	PCS 3E1 CH 2 IN P	B_HDINP2_R	-	PCS 3E1 CH 2 IN P
F12	B_HDINN2_R	-	PCS 3E1 CH 2 IN N	B_HDINN2_R	-	PCS 3E1 CH 2 IN N
K11	VCC12	-		VCC12	-	
A13	B_HDOUTP2_R	-	PCS 3E1 CH 2 OUT P	B_HDOUTP2_R	-	PCS 3E1 CH 2 OUT P
D12	B_VDDOB2_R	-		B_VDDOB2_R	-	
B13	B_HDOUTN2_R	-	PCS 3E1 CH 2 OUT N	B_HDOUTN2_R	-	PCS 3E1 CH 2 OUT N
D13	B_VDDOB3_R	-		B_VDDOB3_R	-	
B14	B_HDOUTN3_R	-	PCS 3E1 CH 3 OUT N	B_HDOUTN3_R	-	PCS 3E1 CH 3 OUT N
L11	VCC12	-		VCC12	-	
A14	B_HDOUTP3_R	-	PCS 3E1 CH 3 OUT P	B_HDOUTP3_R	-	PCS 3E1 CH 3 OUT P
F13	B_HDINN3_R	-	PCS 3E1 CH 3 IN N	B_HDINN3_R	-	PCS 3E1 CH 3 IN N
E13	B_HDINP3_R	-	PCS 3E1 CH 3 IN P	B_HDINP3_R	-	PCS 3E1 CH 3 IN P
G13	VCC12	-		VCC12	-	
E9	B_VDDIB3_R	-		B_VDDIB3_R	-	
L13	VCC12	-		VCC12	-	
J11	B_REFCLKN_R	-		B_REFCLKN_R	-	
H11	B_REFCLKP_R	-		B_REFCLKP_R	-	
M15	PT61D	1	HDC/SI	PT77D	1	HDC/SI
M16	PT61C	1	LDCN/SCS	PT77C	1	LDCN/SCS
F14	PT59B	1	D8/MPI_DATA8	PT77B	1	D8/MPI_DATA8
G14	PT59A	1	CS1/MPI_CS1	PT77A	1	CS1/MPI_CS1
L15	PT58D	1	D9/MPI_DATA9	PT75D	1	D9/MPI_DATA9
L14	PT58C	1	D10/MPI_DATA10	PT75C	1	D10/MPI_DATA10
D14	PT57B	1	CS0N/MPI_CS0N	PT75B	1	CS0N/MPI_CS0N
E14	PT57A	1	RDN/MPI_STRB_N	PT75A	1	RDN/MPI_STRB_N
L16	PT55D	1	WRN/MPI_WR_N	PT74D	1	WRN/MPI_WR_N
K16	PT55C	1	D7/MPI_DATA7	PT74C	1	D7/MPI_DATA7
G15	PT55B	1	D6/MPI_DATA6	PT74B	1	D6/MPI_DATA6

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AD5	PR94C	3	
AE2	PR94B	3	
AD2	PR94A	3	
AC5	PR92D	3	
AB5	PR92C	3	
AF1	PR92B	3	
AE1	PR92A	3	
AA11	PR91D	3	
Y11	PR91C	3	
AC4	PR91B	3	
AB4	PR91A	3	
AA8	PR90D	3	DIFFR_3
AA9	PR90C	3	
AC3	PR90B	3	
AB3	PR90A	3	
AA7	PR79D	3	
Y7	PR79C	3	
AA2	PR79B	3	
Y2	PR79A	3	
AA6	PR77D	3	
Y6	PR77C	3	
Y4	PR77B	3	
W4	PR77A	3	
W11	PR74D	3	
V11	PR74C	3	
W2	PR74B	3	
V2	PR74A	3	
W9	PR71D	3	
V9	PR71C	3	
V1	PR71B	3	
U1	PR71A	3	
W10	PR70D	3	
V10	PR70C	3	
U2	PR70B	3	
T2	PR70A	3	
Y8	PR69D	3	
W8	PR69C	3	VREF1_3
W5	PR69B	3	
V5	PR69A	3	
V7	PR66D	3	PCLKC3_2
U7	PR66C	3	PCLKT3_2
T1	PR66B	3	
R1	PR66A	3	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
D9	B_VDDIB2_R	-	
E12	B_HDINP2_R	-	PCS 3E1 CH 2 IN P
F12	B_HDINN2_R	-	PCS 3E1 CH 2 IN N
K11	VCC12	-	
A13	B_HDOUTP2_R	-	PCS 3E1 CH 2 OUT P
D12	B_VDDOB2_R	-	
B13	B_HDOUTN2_R	-	PCS 3E1 CH 2 OUT N
D13	B_VDDOB3_R	-	
B14	B_HDOUTN3_R	-	PCS 3E1 CH 3 OUT N
L11	VCC12	-	
A14	B_HDOUTP3_R	-	PCS 3E1 CH 3 OUT P
F13	B_HDINN3_R	-	PCS 3E1 CH 3 IN N
E13	B_HDINP3_R	-	PCS 3E1 CH 3 IN P
G13	VCC12	-	
E9	B_VDDIB3_R	-	
L13	VCC12	-	
J11	B_REFCLKN_R	-	
H11	B_REFCLKP_R	-	
M15	PT93D	1	HDC/SI
M16	PT93C	1	LDCN/SCS
F14	PT93B	1	D8/MPI_DATA8
G14	PT93A	1	CS1/MPI_CS1
L15	PT90D	1	D9/MPI_DATA9
L14	PT90C	1	D10/MPI_DATA10
D14	PT90B	1	CS0N/MPI_CS0N
E14	PT90A	1	RDN/MPI_STRB_N
L16	PT89D	1	WRN/MPI_WR_N
K16	PT89C	1	D7/MPI_DATA7
G15	PT89B	1	D6/MPI_DATA6
F15	PT89A	1	D5/MPI_DATA5
K14	PT87D	1	D4/MPI_DATA4
K13	PT87C	1	D3/MPI_DATA3
B15	PT87B	1	D2/MPI_DATA2
A15	PT87A	1	D1/MPI_DATA1
J14	PT86D	1	D16/PCLKC1_3/MPI_DATA16
H14	PT86C	1	D17/PCLKT1_3/MPI_DATA17
A16	PT86B	1	D0/MPI_DATA0
B16	PT86A	1	QOUT/CEON
J13	PT83D	1	VREF2_1
H13	PT83C	1	D18/MPI_DATA18
D15	PT83B	1	DOUT
E15	PT83A	1	MCA_DONE_IN
J16	PT81D	1	D19/PCLKC1_2/MPI_DATA19

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W33	PL42C	7		PL56C	7	
Y33	PL42D	7		PL56D	7	
W37	PL43A	7		PL57A	7	
Y37	PL43B	7		PL57B	7	
Y32	PL43C	7		PL57C	7	
AA32	PL43D	7		PL57D	7	
U38	PL46A	7		PL60A	7	
V38	PL46B	7		PL60B	7	
W34	PL46C	7		PL60C	7	
Y34	PL46D	7		PL60D	7	
T40	PL47A	7	PCLKT7_1	PL61A	7	PCLKT7_1
U40	PL47B	7	PCLKC7_1	PL61B	7	PCLKC7_1
AA33	PL47C	7	PCLKT7_3	PL61C	7	PCLKT7_3
AB33	PL47D	7	PCLKC7_3	PL61D	7	PCLKC7_3
R42	PL48A	7	PCLKT7_0	PL62A	7	PCLKT7_0
T42	PL48B	7	PCLKC7_0	PL62B	7	PCLKC7_0
AA34	PL48C	7	PCLKT7_2	PL62C	7	PCLKT7_2
AB34	PL48D	7	PCLKC7_2	PL62D	7	PCLKC7_2
U41	PL50A	6	PCLKT6_0	PL64A	6	PCLKT6_0
V41	PL50B	6	PCLKC6_0	PL64B	6	PCLKC6_0
V36	PL50C	6	PCLKT6_1	PL64C	6	PCLKT6_1
W36	PL50D	6	PCLKC6_1	PL64D	6	PCLKC6_1
U42	PL51A	6		PL65A	6	
V42	PL51B	6		PL65B	6	
AB31	PL51C	6	PCLKT6_3	PL65C	6	PCLKT6_3
AC31	PL51D	6	PCLKC6_3	PL65D	6	PCLKC6_3
W38	PL52A	6		PL66A	6	
Y38	PL52B	6		PL66B	6	
AA35	PL52C	6	PCLKT6_2	PL66C	6	PCLKT6_2
AB35	PL52D	6	PCLKC6_2	PL66D	6	PCLKC6_2
W39	PL55A	6		PL69A	6	
Y39	PL55B	6		PL69B	6	
AB32	PL55C	6	VREF1_6	PL69C	6	VREF1_6
AC32	PL55D	6		PL69D	6	
W40	PL56A	6		PL70A	6	
Y40	PL56B	6		PL70B	6	
AA36	PL56C	6		PL70C	6	
AB36	PL56D	6		PL70D	6	
W41	PL57A	6		PL71A	6	
Y41	PL57B	6		PL71B	6	
AA37	PL57C	6		PL71C	6	
AB37	PL57D	6		PL71D	6	
W42	PL59A	6		PL73A	6	
Y42	PL59B	6		PL73B	6	
AC33	PL59C	6		PL73C	6	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AU9	PB103C	4		PB117C	4	
AU8	PB103D	4		PB117D	4	
AY8	PB104A	4		PB118A	4	
AY7	PB104B	4		PB118B	4	
AU7	PB104C	4		PB118C	4	
AU6	PB104D	4		PB118D	4	
BA7	PB105A	4		PB119A	4	
BA6	PB105B	4		PB119B	4	
AN13	PB105C	4		PB119C	4	
AN12	PB105D	4		PB119D	4	
AV9	PB107A	4		PB121A	4	
AV8	PB107B	4		PB121B	4	
AT10	PB107C	4		PB121C	4	
AT9	PB107D	4		PB121D	4	
AW8	PB108A	4		PB122A	4	
AW7	PB108B	4		PB122B	4	
AP11	PB108C	4		PB122C	4	
AP10	PB108D	4		PB122D	4	
BB5	PB109A	4		PB123A	4	
BB4	PB109B	4		PB123B	4	
AR10	PB109C	4		PB123C	4	
AR9	PB109D	4		PB123D	4	
BA5	PB111A	4		PB125A	4	
BA4	PB111B	4		PB125B	4	
AT7	PB111C	4		PB125C	4	
AT6	PB111D	4		PB125D	4	
BB3	PB112A	4		PB126A	4	
BA3	PB112B	4		PB126B	4	
AM14	PB112C	4		PB126C	4	
AL14	PB112D	4		PB126D	4	
AY5	PB113A	4		PB127A	4	
AY4	PB113B	4		PB127B	4	
AN11	PB113C	4		PB127C	4	
AN10	PB113D	4		PB127D	4	
AV7	PB115A	4		PB129A	4	
AV6	PB115B	4		PB129B	4	
AM12	PB115C	4		PB129C	4	
AM11	PB115D	4		PB129D	4	
AW5	PB116A	4		PB130A	4	
AW4	PB116B	4		PB130B	4	
AT5	PB116C	4		PB130C	4	
AT4	PB116D	4		PB130D	4	
AY2	PB117A	4		PB131A	4	
BA2	PB117B	4		PB131B	4	
AP9	PB117C	4		PB131C	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP1	PR90B	3		PR109B	3	
AN1	PR90A	3		PR109A	3	
AK10	PR89D	3	VREF2_3	PR107D	3	VREF2_3
AJ10	PR89C	3		PR107C	3	
AM5	PR89B	3		PR107B	3	
AL5	PR89A	3		PR107A	3	
AL7	PR86D	3		PR104D	3	
AK7	PR86C	3		PR104C	3	
AM1	PR86B	3		PR104B	3	
AL1	PR86A	3		PR104A	3	
AJ11	PR85D	3		PR103D	3	
AH11	PR85C	3		PR103C	3	
AK5	PR85B	3		PR103B	3	
AJ5	PR85A	3		PR103A	3	
AK9	PR84D	3		PR99D	3	
AJ9	PR84C	3		PR99C	3	
AK3	PR84B	3		PR99B	3	
AJ3	PR84A	3		PR99A	3	
AK6	PR82D	3		PR98D	3	
AJ6	PR82C	3		PR98C	3	
AK2	PR82B	3		PR98B	3	
AJ2	PR82A	3		PR98A	3	
AH10	PR81D	3		PR96D	3	
AG10	PR81C	3		PR96C	3	
AK1	PR81B	3		PR96B	3	
AJ1	PR81A	3		PR96A	3	
AH9	PR80D	3		PR94D	3	
AG9	PR80C	3		PR94C	3	
AH2	PR80B	3		PR94B	3	
AG2	PR80A	3		PR94A	3	
AH8	PR78D	3		PR92D	3	
AG8	PR78C	3		PR92C	3	
AG1	PR78B	3		PR92B	3	
AH1	PR78A	3		PR92A	3	
AG14	PR77D	3		PR91D	3	
AF14	PR77C	3		PR91C	3	
AG4	PR77B	3		PR91B	3	
AF4	PR77A	3		PR91A	3	
AH7	PR76D	3	DIFFR_3	PR90D	3	DIFFR_3
AG7	PR76C	3		PR90C	3	
AG3	PR76B	3		PR90B	3	
AF3	PR76A	3		PR90A	3	
AH6	PR74D	3		PR88D	3	
AG6	PR74C	3		PR88C	3	
AF1	PR74B	3		PR88B	3	

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-7FF1020C[1]	-7	Organic fcBGA	1020	COM	40.4
LFSC3GA40E-6FF1020C[1]	-6	Organic fcBGA	1020	COM	40.4
LFSC3GA40E-5FF1020C[1]	-5	Organic fcBGA	1020	COM	40.4
LFSC3GA40E-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-7FC1152C[2]	-7	Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-6FC1152C[2]	-6	Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-5FC1152C[2]	-5	Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-7FF1152C	-7	Organic fcBGA	1152	COM	40.4
LFSC3GA40E-6FF1152C	-6	Organic fcBGA	1152	COM	40.4
LFSC3GA40E-5FF1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-7FF1020C[1]	-7	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-6FF1020C[1]	-6	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-5FF1020C[1]	-5	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-7FFA1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-6FFA1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-5FFA1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-7FC1152C[2]	-7	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FC1152C[2]	-6	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FC1152C[2]	-5	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-7FF1152C	-7	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FF1152C	-6	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FF1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Date	Version	Section	Change Summary
March 2007 (cont.)	01.5 (cont.)	DC and Switching Characteristics (cont.)	Updated LatticeSC Internal Timing Parameters with ispLEVER 6.1 SP1 results.
			Updated t_{FDEL} and t_{CDEL} specifications.
			Updated LatticeSC Family Timing Adders with ispLEVER 6.1 SP1 results.
			Updated PLL specifications to expand frequency range down to 2 MHz and break out jitter for the different ranges.
			Added footnote to sysCLOCK PLL Timing table specifying the conditions for the jitter measurements.
			Added t_{DLL} specification to sysCLOCK DLL Timing table.
			Added footnote to sysCLOCK DLL Timing table specifying the conditions for the jitter measurements.
			Added sysCONFIG Master Parallel Configuration Mode and sysCONFIG SPI Port to LatticeSC sysCONFIG Port Timing table.
		Pin Information	Updated Pin Information Summary with SC40 information.
			Updated LFSC25 Logic Signal Connections: FF1020 with SC40 information.
			Updated LFSC80 Logic Signal Connections: FC1152 with SC40 information.
August 2007	01.6	General	Changed references of "HDC" to "HDC/SI".
			Changed references of "LDCN" to "LDCN/SCS".
			Changed references of "BUSYN/RCLK" to "BUSYN/RCLK/SCK".
			Changed references of "RDCFGN" to "TSALLN".
			Changed references of "TDO/RDDATA" to "TDO".
		Architecture	Updated text in Ripple Mode section.
			Added information to Global Set/Reset.
			Added information for Spread Spectrum Clocking
			Modified information for PLL/DLL Cascading. DLL to PLL is now supported.
			Modified AIL Block text and figure.
			Modified Figure 2-20 DDR/Shift Register Block.
			Added Information to Hot Socketing.
			Added new information for I/O Architecture Rules.
			Added information to SERDES Power Supply Sequencing Requirements.
		DC and Switching Characteristics	Added footnote to Hot Socketing Specifications table.
			Modified Initialization and Standby Supply Current table.
			Modified GSR Timing table.
			Modified sysCLOCK DLL Timing table to include $I_{DUTY.}$
			Deleted Readback Timing information from sysCONFIG Port Timing table.
			Modified data in External Switching Characteristics table.
		Pin Information	Added information to the Signal Descriptions table for HDC/SI, LDCN/SCS.
			Added footnote to Signal Descriptions table.
			Modified Description for signal BUSYN/RCLK/SCK.
			Modified data in Pin Information Summary and device-specific Pinout Information tables.